Edgebanding

Application Systems



Durable systems. Consistent performance.

offers rugged and precise applicators for edgebanding application needs with special features to eliminate warped and carved board issues. In addition, the industry proven reliable MCP-4C control brings savings with unneeded operation adjustment and automatic shut-off. With reduced glue usage up to 70%, scrap, rework. glue pot and roller, and controllable, repeatable process at all machine speeds the Melton Edgebanding System saves both time and money with improved production quality to bring you a quality solution.

MELION's applicators offer:

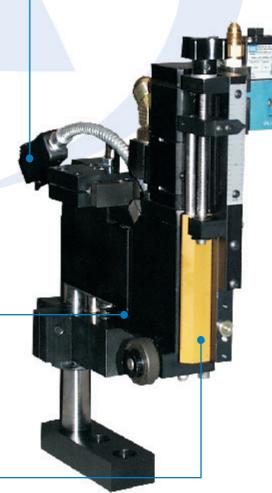
- Micro-adjustable to perfectly conform to the board.
- Spring tension allows smooth contact between applicator and board.
- Precision-bearing-follower guides pieces into applicator head, eliminating issues with warped or curved board.
- Extremely rigid construction is designed for the rugged environment of a woodworking facility.
- "Snuff-back" valve for clean glue pattern starts and stops at any speed.
- A hardened applicator is used for excellent wearresistance and long-life.

MELION's MCP-4C control offers:

- Automatic-motor-speed tracking for glue volume to remain consistent during changes in machine speed
- Automatic valve shut off when a board stops in the application area and opens as soon as the machine begins again, eliminating wasted boards



Available in a wide range of units with different tank sizes and melt rates, including PUR application systems. Unique grid melting systems reduce heat-up time.



Unique Valco software allows any board length to be glued without operator adjustment.





Edgebanding Application Systems



Units feature an easy-to-use touch pad with a bright vacuumflourescent screen which allows operators to quickly setup system parameters and monitor system operation.

THE TOTAL PACKAGE.

The **MELION** range of products offer a complete selection of hot melt components and support equipment:

RTD hot melt hoses

Manual and automatic dispensing valves

Nozzle and applicator styles

Mounting bracket packages

Solid-state pattern control systems

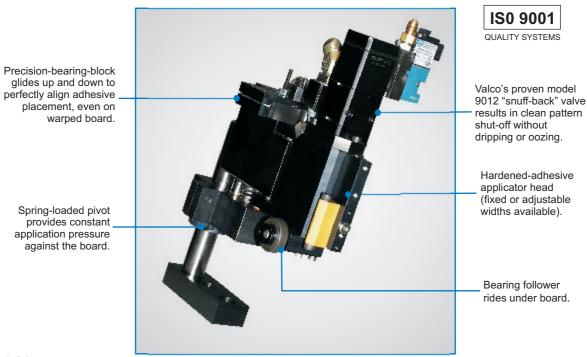
In-line filters

Replacement parts for competitive systems

High-performance hot melt adhesives

Cost-effective rebuild/exchange programs

Technical Specifications



WHY BEADS?

- Beads compress to provide better gap filling and edge definition on rough board, reducing air pockets and "flaking."
- Head angle and pitch are not as critical as with slot-coating, reducing setup time.
- When used with \sum_\equiv \seta \sum_\equiv \seta \



